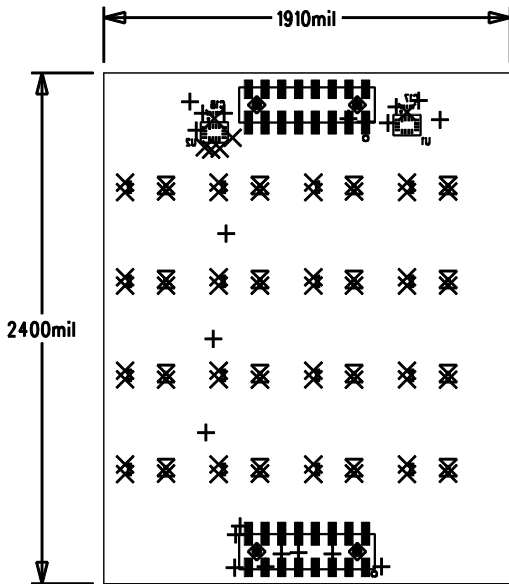


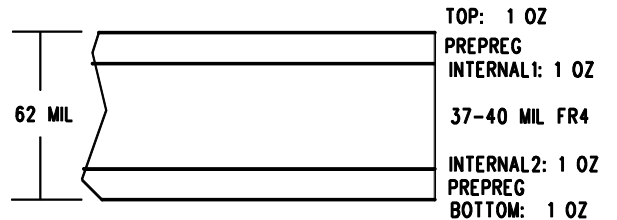
SIZE	QTY	SYM	PLATED	TOL
13	21	+	YES	+/-0.0
10	54	×	YES	+/-0.0
47.24	4	◇	NO	+/-0.0
22	16	⊗	NO	+/-0.0



LAYER NAME	#	ASSEMBLY BOARD	BOARD	NET	ITEM	TOM
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Overall Board Thickness: 62 Mil
 Soldermask Color: Red
 Silkscreen Color: White
 Drill hole tolerance: +/-3 Mil
 Copper/Spacing Clearances: 5/5 Mil

COMPANY	TI-SVA		
PCB PART NUMBER	DK16	REV	2
DATE	12/10/14		
NOTES			



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